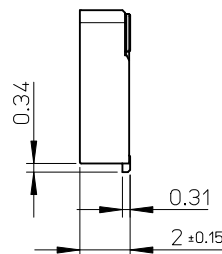
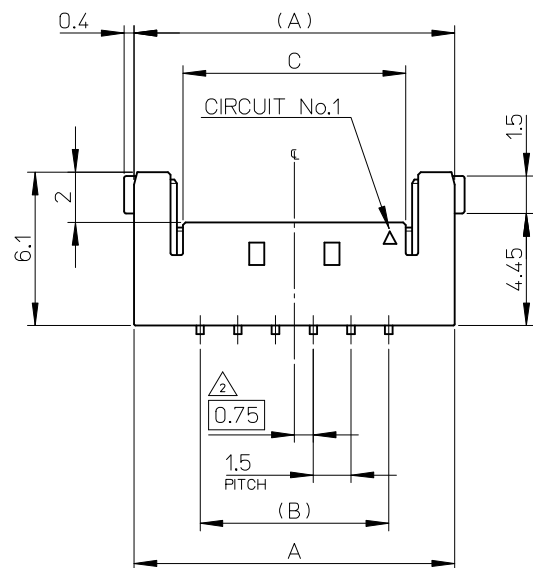
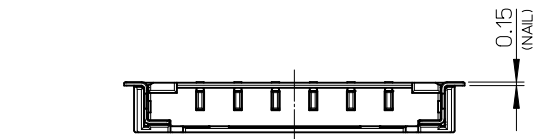


10 9 8 7 6 5 4 3 2 1

NOTE.

1. 嵌合相手 : 504051****
MATE WITH : 504051****
偶数極の製品に適用
APPLY EVEN CIRCUIT PRODUCTS.
3. 材質
MATERIAL
ハウジング : 耐熱性樹脂 UL94-V0 BLACK
HOUSING : HEATPROOF RESIN UL94-V0 BLACK
ターミナル : 銅合金
TERMINAL : COPPER ALLOY
ネール : 銅合金
NAIL : COPPER ALLOY
4. メッキ
PLATING
ターミナル : 下地 ニッケルメッキ、コンタクト・半田付け部 金メッキ
TERMINAL : UNDER NICKEL PLATING
CONTACT AND TAIL GOLD PLATING
ネール : 下地 ニッケルメッキ、錫メッキ
NAIL : UNDER NICKEL PLATING , TIN PLATING
5. ELV及びRoHS適合品
ELV AND RoHS COMPLIANT.



17.85	16.5	21.75	5040501291	12
14.85	13.5	18.75	5040501091	10
11.85	10.5	15.75	5040500891	8
10.35	9.0	14.25	5040500791	7
8.85	7.5	12.75	5040500691	6
5.85	4.5	9.75	5040500491	4
C	B	A	EMBOSSED PACKAGE	CIRCUIT
			ORDER No.	
CONNECTOR SERIES No. : 504050**91				

REVISED EC NO: J2014-1166 DRWN:YWAKE CHKD:KASAKAWA APPR:NUKITA D	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY THANYU	DATE 2012/03/29	TITLE 1.5 WIRE TO BOARD CONN. R/A H=2MM HEADER ASS'Y molex DOCUMENT NO. SD-504050-001		
		10 OVER 30 UNDER	± 0.25	CHECKED BY KASAKAWA	DATE 2012/03/29			
		30 OVER	± 0.3	APPROVED BY Y01TO	DATE 2012/04/18			
		ANGULAR ±3 °		MATERIAL NO. SEE CHART				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
						SHEET NO. 1 OF 2		

9 8 7 6 5 4 3 2

10 9 8 7 6 5 4 3 2 1

F

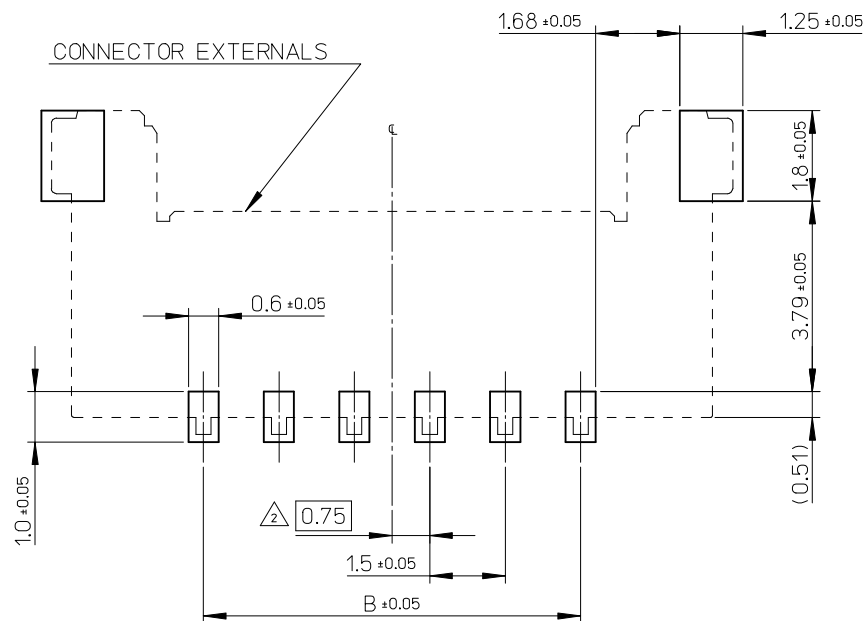
E

D

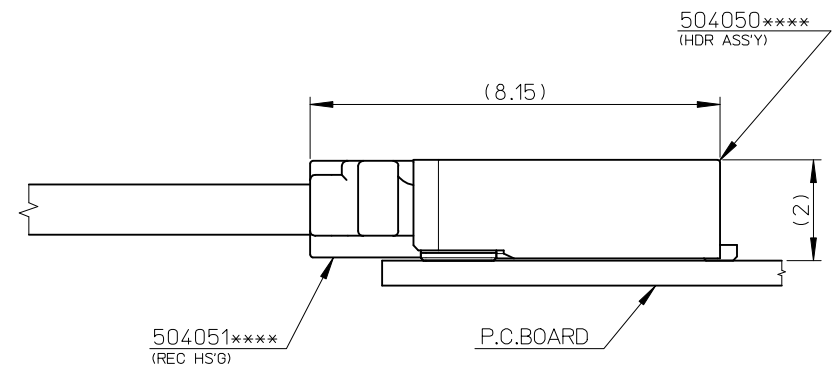
C

B

A



RECOMMENDED PATTERN LAYOUT (REF.)



MATED CONNECTORS

REVISED EC NO: J2014-1166 DRWN: YMAKE CHKD: KASAKAWA APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY THANYU	DATE 2012/03/29	TITLE 1.5 WIRE TO BOARD CONN. R/A H=2MM HEADER ASS'Y				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KASAKAWA	DATE 2012/03/29					
		30 OVER	± 0.3	APPROVED BY YOITO	DATE 2012/04/18	molex				
		ANGULAR ±3 °		MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-504050-001			2 OF 2		
	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

10 9 8 7 6 5 4 3 2 1

F

F

E

E

D

D

C

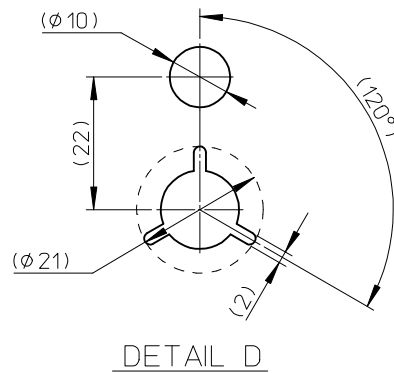
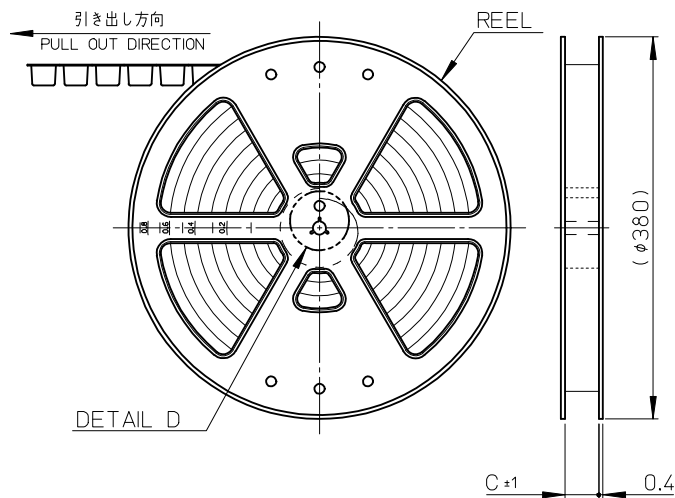
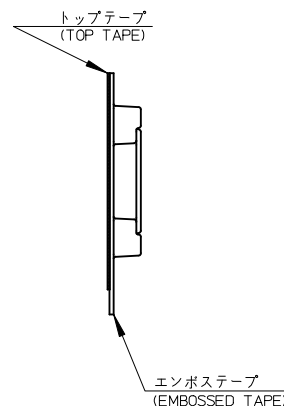
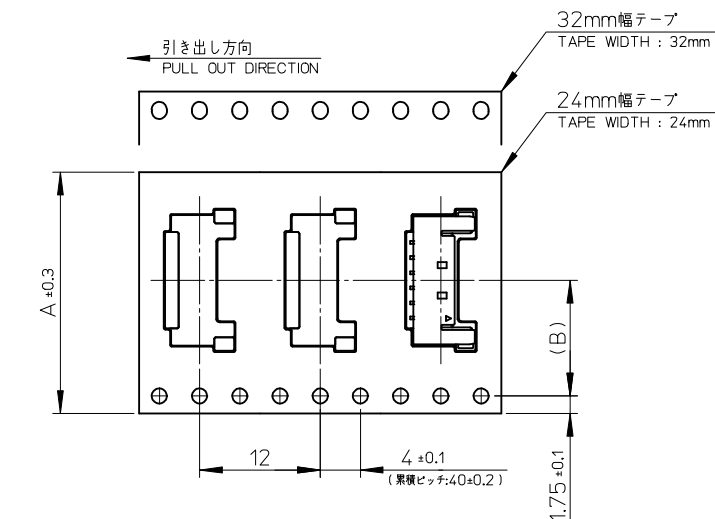
C

B

B

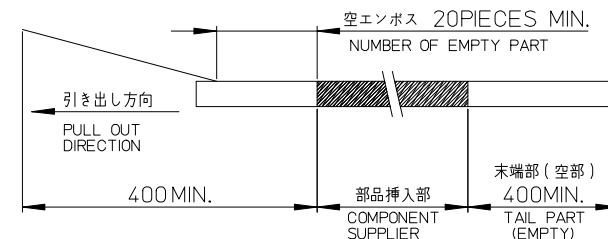
A

A



NOTE

- 梱包数量 : 2700個 / リール
NUMBER OF CONNECTORS : 2700 PIECES/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- 材料
MATERIALS
キャリアテープ : ポリスチレン
CARRIER TAPE : POLYSTYRENE
トップテープ : ポリエステル、ポリエチレン、ポリエチレンテレフタレート
TOP TAPE : POLYESTER, POLYETHYLENE, POLYETHYLENE TEREPHTHALATE
リール : ポリスチレン (リサイクル材を含む)
REEL : POLYSTYRENE (RECYCLE MATERIAL CONTAINED)
- 製品詳細寸法については、RSD-504050-001を参照して下さい。
PLEASE REFER TO RSD-504050-001 FOR THE DETAILED DIMENSION OF THE CONNECTOR.
- ELV及びRoHS適合品
ELV AND RoHS COMPLIANT.
- トップテープの剥離強度については、IEC60286-3に準拠の事。
TOP TAPE PEEL FORCE IS DEFINED BY IEC60286-3.

45.5	20.2	44	5040501291	12
33.5	14.2	32	5040501091	10
33.5	14.2	32	5040500891	8
25.5	11.5	24	5040500791	7
25.5	11.5	24	5040500691	6
25.5	11.5	24	5040500491	4
C	B	A	ORDER No.	CIRCUIT
		WIDTH OF TAPE		

REVISED EC NO: J2014-1166 DRWN:YMAKE CHKD:KASAKAWA APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY THANYU	DATE 2012/03/29	TITLE EMBOSSED TAPE PACKAGE FOR 504050-**** (1.5 W/B CONN. H=2MM)				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KASAKAWA	DATE 2012/03/29					
		30 OVER	± 0.3	APPROVED BY Y01T0	DATE 2012/04/18	molex				
		ANGULAR ±3 °		MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-504050-002		1 OF 1			
D	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					